

**RECORDATION FORM
COVER SHEET
PATENT ONLY**

First Named Inventor	Yat Hung Ho
Title	Combination Lock with Backup Key
Attorney Docket Number	HKPC/416DES/US
Date	July 28, 2006

Mail Stop Assignment Recordation Services Director of the United States Patent and Trademark Office, P.O. Box 1450, Alexandria, Virginia 22313-1450

Please record the attached document.

08-04-2006

1. Name of conveying party(ies):

Yat Hung Ho



103286460

2. Name and address of receiving party(ies):

Name: Alloy Metal Manufactory Ltd.
 Street Address: Flat H, 3/F., On Ho Ind. Bldg.
 17-19 Shing Wan Road, Tai Wai, Shatin
 City, State, ZIP: New Territories, Hong Kong
 Country: China

Country of Incorporation: Hong Kong

3. Nature of Conveyance: Assignment

Execution Date: July 19, 2006

4. This document is being filed with a new application,
 the execution date of which is: July 19, 2006

5. Name and address of party to whom correspondence document should be mailed:

Guy D. Yale, Esq.
 Alix, Yale & Ristas, LLP
 750 Main Street, Suite 1400
 Hartford, CT 06103-2721

6. Total number of applications involved: 1

7. Total fee enclosed: \$40.00. If this amount is incorrect, please charge or credit the difference to Deposit Account No. 16-2563.

8. Total number of pages including cover sheet, attachments and documents: 3

To the best of my knowledge and belief, the foregoing information is true and correct.

SIGNATURE OF APPLICANT, ATTORNEY OR AGENT

Firm or Individual name

Guy D. Yale

Reg. No.

29,125

Signature

[Handwritten signature of Guy D. Yale]

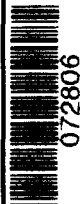
Date

July 28, 2006

Attorney's Docket No.

HKPC/416DES/US

112921 U.S. PTO
29/263727



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ASSIGNMENT

WHEREAS, I, Yat Hung Ho, residing at Flat H, 3/F., On Ho Ind. Bldg., 17-19 Shing Wan Road, Tai Wai, Shatin, New Territories, Hong Kong, China, have invented new and useful improvements in

Combination Lock with Backup Key

for which I am making application for Letters Patent of the United States, which application was executed by me on the _____ day of _____ 2006; and

WHEREAS, Alloy Metal Manufactory Ltd., a Hong Kong corporation, having a place of business at Flat H, 3/F., On Ho Ind. Bldg., 17-19 Shing Wan Road, Tai Wai, Shatin, New Territories, Hong Kong, China, is desirous of acquiring the entire right, title and interest in and to said improvements and any Letters Patent which may be granted thereon;

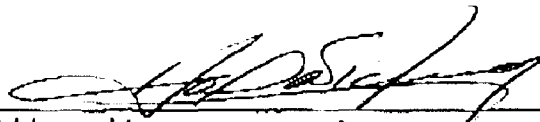
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, ~~be it known that for~~ and in consideration of the sum of One Dollar (\$1.00) to me in hand paid and other good and valuable consideration, receipt of which is hereby acknowledged, I, the said Yat Hung Ho, sell, assign and transfer to Alloy Metal Manufactory Ltd., its successors and assigns (hereinafter called "Assignee"), the entire right, title and interest in and to said improvements and in and to any Letters Patent which may be obtained thereon in the United States, together with said application and all divisional, continuing, substitute, renewal, reissue, and other applications for Letters Patent which have been or may be filed on said improvements in the United States, the same to be held and enjoyed by the Assignee for its and their sole use and behoof.

I hereby authorize and request the Commissioner of Patents and Trademarks to issue all Letters Patent of the United States on said improvements to the Assignee.

I further covenant and agree that when requested by the Assignee, and without further consideration, but at the cost and expense of the Assignee, I will execute and deliver all applications for patent on said improvements, execute all lawful oaths and other papers, supply to the Assignee all facts and evidence known to me relating to said improvements and the history and development thereof, testify in all interferences, suits, and other legal proceedings, and generally do everything rightful which the Assignee shall consider desirable for aiding in securing, maintaining, and enforcing proper patent protection for said improvements and for vesting the title to said improvements in the Assignee.

I further covenant that I have the lawful right to assign the interest in said improvements in the manner and form as herein expressed, that the interests herein conveyed are free from prior assignment, grant, mortgage, license, or other encumbrance whatsoever and that the execution of this Assignment is my own free act and deed.

Date: 19 July 2006



Yat Hung Ho



Witness



Witness